Features

- **Fast Read Access Time – 120 ns**
- **Automatic Page Write Operation**
  - **Internal Address and Data Latches for 128 Bytes**
  - **Internal Control Timer**
- **Fast Write Cycle Time**
  - **Page Write Cycle Time – 10 ms Maximum**
  - **1 to 128-byte Page Write Operation**
- **Low Power Dissipation**
  - **40 mA Active Current**
  - **200 µA CMOS Standby Current**
- **Hardware and Software Data Protection**
- **$\overline{\text{DATA}}$ Polling for End of Write Detection**
- **High Reliability CMOS Technology**
  - **Endurance: 10^4 or 10^5 Cycles**
  - **Data Retention: 10 Years**
- **Single 5V ±10% Supply**
- **CMOS and TTL Compatible Inputs and Outputs**
- **JEDEC Approved Byte-wide Pinout**
- **Industrial Temperature Ranges**
- **Green (Pb/Halide-free) Packaging Option**

1. Description

The AT28C010 is a high-performance electrically-erasable and programmable read-only memory. Its 1 megabit of memory is organized as 131,072 words by 8 bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 120 ns with power dissipation of just 220 mW. When the device is deselected, the CMOS standby current is less than 200 µA.

The AT28C010 is accessed like a Static RAM for the read or write cycle without the need for external components. The device contains a 128-byte page register to allow writing of up to 128 bytes simultaneously. During a write cycle, the address and 1 to 128 bytes of data are internally latched, freeing the address and data bus for other operations. Following the initiation of a write cycle, the device will automatically write the latched data using an internal control timer. The end of a write cycle can be detected by $\overline{\text{DATA}}$ polling of I/O7. Once the end of a write cycle has been detected a new access for a read or write can begin.

Atmel's AT28C010 has additional features to ensure high quality and manufacturability. The device utilizes internal error correction for extended endurance and improved data retention characteristics. An optional software data protection mechanism is available to guard against inadvertent writes. The device also includes an extra 128 bytes of EEPROM for device identification or tracking.
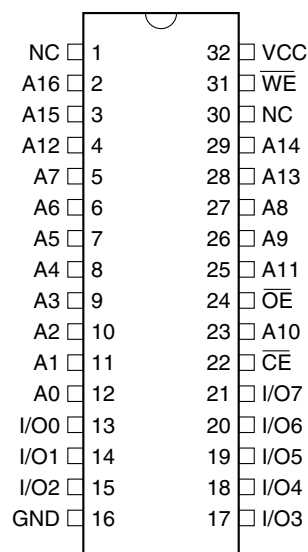
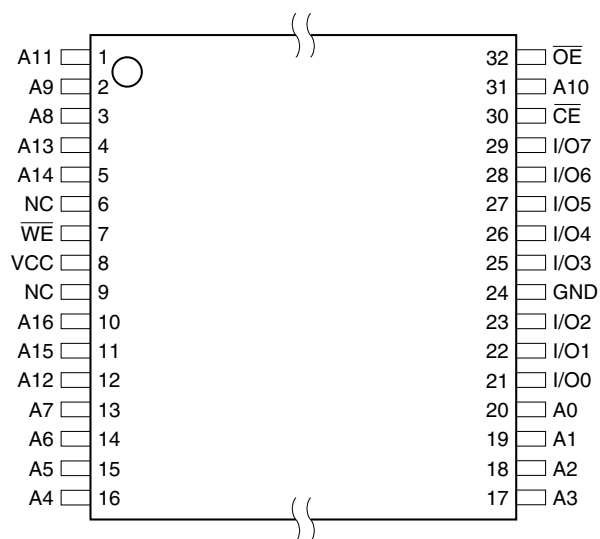**1-megabit (128K x 8) Paged Parallel EEPROM**

AT28C010

2. Pin Configurations

Pin Name	Function
A0 - A16	Addresses
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
$\overline{WE}$	Write Enable
I/O0 - I/O7	Data Inputs/Outputs
NC	No Connect
DC	Don't Connect

2.2   32-lead PDIP Top View

```
NC   1        32  VCC
A16  2        31  WE
A15  3        30  NC
A12  4        29  A14
A7   5        28  A13
A6   6        27  A8
A5   7        26  A9
A4   8        25  A11
A3   9        24  OE
A2   10       23  A10
A1   11       22  CE
A0   12       21  I/O7
I/O0 13       20  I/O6
I/O1 14       19  I/O5
I/O2 15       18  I/O4
GND  16       17  I/O3
```

2.1   32-lead TSOP Top View

```
A11  1        32  OE
A9   2        31  A10
A8   3        30  CE
A13  4        29  I/O7
A14  5        28  I/O6
NC   6        27  I/O5
WE   7        26  I/O4
VCC  8        25  I/O3
NC   9        24  GND
A16  10       23  I/O2
A15  11       22  I/O1
A12  12       21  I/O0
A7   13       20  A0
A6   14       19  A1
A5   15       18  A2
A4   16       17  A3
```

2.3   32-lead PLCC Top View

```
        A12 A15 A16 DC VCC WE NC
        4   3   2   1  32  31 30
A7   5                        29  A14
A6   6                        28  A13
A5   7                        27  A8
A4   8                        26  A9
A3   9                        25  A11
A2   10                       24  OE
A1   11                       23  A10
A0   12                       22  CE
I/O0 13                       21  I/O7
        14  15  16  17 18  19 20
      I/O1 I/O2 GND I/O3 I/O4 I/O5 I/O6
```
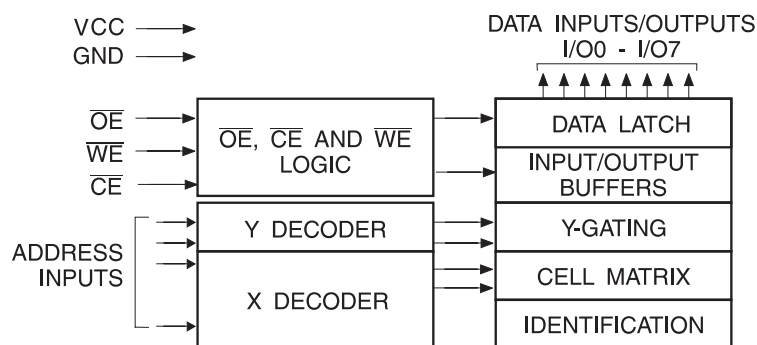
Note: PLCC package pin 1 is Don't Connect.

3. Block Diagram

4. Device Operation

4.1 Read

The AT28C010 is accessed like a Static RAM. When $\overline{CE}$ and $\overline{OE}$ are low and $\overline{WE}$ is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state when either $\overline{CE}$ or $\overline{OE}$ is high. This dual-line control gives designers flexibility in preventing bus contention in their system.

4.2 Byte Write

A low pulse on the $\overline{WE}$ or $\overline{CE}$ input with $\overline{CE}$ or $\overline{WE}$ low (respectively) and $\overline{OE}$ high initiates a write cycle. The address is latched on the falling edge of $\overline{CE}$ or $\overline{WE}$, whichever occurs last. The data is latched by the first rising edge of $\overline{CE}$ or $\overline{WE}$. Once a byte write has been started it will automatically time itself to completion. Once a programming operation has been initiated and for the duration of t_{WC}, a read operation will effectively be a polling operation.

4.3 Page Write

The page write operation of the AT28C010 allows 1 to 128 bytes of data to be written into the device during a single internal programming period. A page write operation is initiated in the same manner as a byte write; the first byte written can then be followed by 1 to 127 additional bytes. Each successive byte must be written within 150 µs (t_{BLC}) of the previous byte. If the t_{BLC} limit is exceeded the AT28C010 will cease accepting data and commence the internal programming operation. All bytes during a page write operation must reside on the same page as defined by the state of the A7 - A16 inputs. For each $\overline{WE}$ high to low transition during the page write operation, A7 - A16 must be the same.

The A0 to A6 inputs are used to specify which bytes within the page are to be written. The bytes may be loaded in any order and may be altered within the same load period. Only bytes which are specified for writing will be written; unnecessary cycling of other bytes within the page does not occur.

4.4 $\overline{DATA}$ Polling

The AT28C010 features $\overline{DATA}$ Polling to indicate the end of a write cycle. During a byte or page write cycle an attempted read of the last byte written will result in the complement of the written data to be presented on I/O$_7$. Once the write cycle has been completed, true data is valid on all outputs, and the next write cycle may begin. $\overline{DATA}$ Polling may begin at anytime during the write cycle.

4.5 Toggle Bit

In addition to $\overline{\text{DATA}}$ Polling the AT28C010 provides another method for determining the end of a write cycle. During the write operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the write has completed, I/O6 will stop toggling and valid data will be read. Reading the toggle bit may begin at any time during the write cycle.

4.6 Data Protection

If precautions are not taken, inadvertent writes may occur during transitions of the host system power supply. Atmel® has incorporated both hardware and software features that will protect the memory against inadvertent writes.

4.6.1 Hardware Protection

Hardware features protect against inadvertent writes to the AT28C010 in the following ways: (a) V_{CC} sense – if V_{CC} is below 3.8V (typical) the write function is inhibited; (b) V_{CC} power-on delay – once V_{CC} has reached 3.8V the device will automatically time out 5 ms (typical) before allowing a write; (c) write inhibit – holding any one of $\overline{\text{OE}}$ low, $\overline{\text{CE}}$ high or $\overline{\text{WE}}$ high inhibits write cycles; and (d) noise filter—pulses of less than 15 ns (typical) on the $\overline{\text{WE}}$ or $\overline{\text{CE}}$ inputs will not initiate a write cycle.

4.6.2 Software Data Protection

A software controlled data protection feature has been implemented on the AT28C010. When enabled, the software data protection (SDP), will prevent inadvertent writes. The SDP feature may be enabled or disabled by the user; the AT28C010 is shipped from Atmel with SDP disabled.

SDP is enabled by the host system issuing a series of three write commands; three specific bytes of data are written to three specific addresses (refer to Software Data Protection Algorithm). After writing the 3-byte command sequence and after t_{WC} the entire AT28C010 will be protected against inadvertent write operations. It should be noted, that once protected the host may still perform a byte or page write to the AT28C010. This is done by preceding the data to be written by the same 3-byte command sequence used to enable SDP.

Once set, SDP will remain active unless the disable command sequence is issued. Power transitions do not disable SDP and SDP will protect the AT28C010 during power-up and power-down conditions. All command sequences must conform to the page write timing specifications. The data in the enable and disable command sequences is not written to the device and the memory addresses used in the sequence may be written with data in either a byte or page write operation.

After setting SDP, any attempt to write to the device without the 3-byte command sequence will start the internal write timers. No data will be written to the device; however, for the duration of t_{WC}, read operations will effectively be polling operations.

4.7 Device Identification

An extra 128 bytes of EEPROM memory are available to the user for device identification. By raising A9 to 12V $\pm$ 0.5V and using address locations 1FF80H to 1FFFFH the bytes may be written to or read from in the same manner as the regular memory array.

4.8 Optional Chip Erase Mode

The entire device can be erased using a 6-byte software code. Please see Software Chip Erase application note for details.

5. DC and AC Operating Range

		AT28C010-12	AT28C010-15
Operating Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C
V_{CC} Power Supply		5V ±10%	5V ±10%

6. Operating Modes

Mode	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	I/O
Read	V_{IL}	V_{IL}	V_{IH}	D_{OUT}
Write[2]	V_{IL}	V_{IH}	V_{IL}	D_{IN}
Standby/Write Inhibit	V_{IH}	X[1]	X	High Z
Write Inhibit	X	X	V_{IH}	
Write Inhibit	X	V_{IL}	X	
Output Disable	X	V_{IH}	X	High Z

Notes: 1. X can be V_{IL} or V_{IH}.
2. Refer to AC Programming Waveforms.

7. Absolute Maximum Ratings*

Temperature Under Bias .... -55°C to +125°C

Storage Temperature .... -65°C to +150°C

All Input Voltages
(including NC Pins)
with Respect to Ground ....-0.6V to +6.25V

All Output Voltages
with Respect to Ground ....-0.6V to V_{CC} + 0.6V

Voltage on $\overline{OE}$ and A9
with Respect to Ground ....-0.6V to +13.5V

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

8. DC Characteristics

Symbol	Parameter	Condition	Min	Max	Units
I_{LI}	Input Load Current	V_{IN} = 0V to V_{CC} + 1V		10	µA
I_{LO}	Output Leakage Current	$V_{I/O}$ = 0V to V_{CC}		10	µA
I_{SB1}	V_{CC} Standby Current CMOS	$\overline{CE}$ = V_{CC} - 0.3V to V_{CC} + 1V		200	µA
I_{SB2}	V_{CC} Standby Current TTL	$\overline{CE}$ = 2.0V to V_{CC} + 1V		3	mA
I_{CC}	V_{CC} Active Current	f = 5 MHz; I_{OUT} = 0 mA		40	mA
V_{IL}	Input Low Voltage			0.8	V
V_{IH}	Input High Voltage		2.0		V
V_{OL}	Output Low Voltage	I_{OL} = 2.1 mA		0.45	V
V_{OH1}	Output High Voltage	I_{OH} = -400 µA	2.4		V
V_{OH2}	Output High Voltage CMOS	I_{OH} = -100 µA; V_{CC} = 4.5V	4.2		V

9. AC Read Characteristics

Symbol	Parameter	AT28C010-12		AT28C010-15		Units
		Min	Max	Min	Max	
t_{ACC}	Address to Output Delay		120		150	ns
t_{CE}[1]	$\overline{CE}$ to Output Delay		120		150	ns
t_{OE}[2]	$\overline{OE}$ to Output Delay	0	50	0	55	ns
t_{DF}[3][4]	$\overline{CE}$ or $\overline{OE}$ to Output Float	0	50	0	55	ns
t_{OH}	Output Hold from $\overline{OE}$, $\overline{CE}$ or Address, Whichever Occurred First	0		0		ns

10. AC Read Waveforms[1][2][3][4]
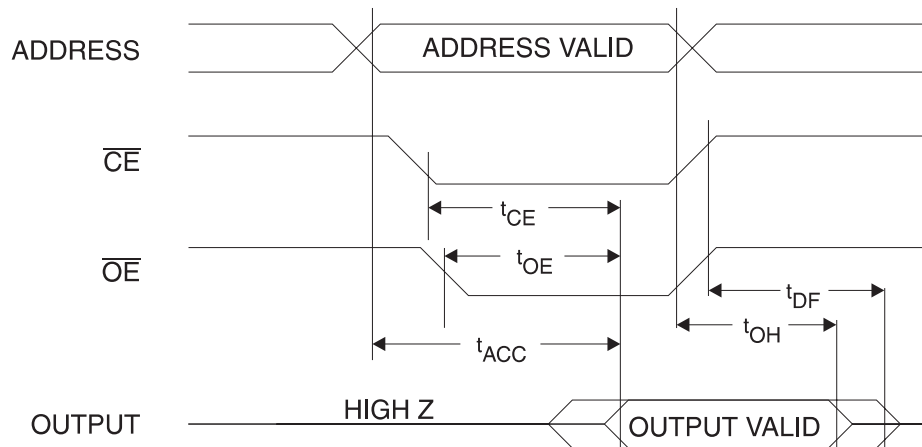
Notes: 1. $\overline{CE}$ may be delayed up to t_{ACC} - t_{CE} after the address transition without impact on t_{ACC}.

2. $\overline{OE}$ may be delayed up to t_{CE} - t_{OE} after the falling edge of $\overline{CE}$ without impact on t_{CE} or by t_{ACC} - t_{OE} after an address change without impact on t_{ACC}.

3. t_{DF} is specified from $\overline{OE}$ or $\overline{CE}$ whichever occurs first (C_L = 5 pF).

4. This parameter is characterized and is not 100% tested.

11. Input Test Waveforms and Measurement Level

AC DRIVING LEVELS

3.0V

0.0V

1.5V

AC MEASUREMENT LEVEL

t_R, t_F < 5 ns

12. Output Test Load

5.0V

1.8K

OUTPUT PIN

1.3K

100 pF
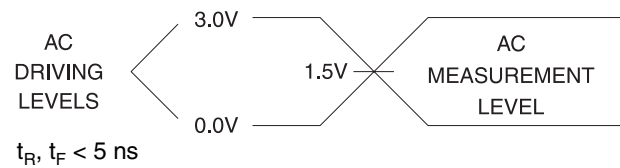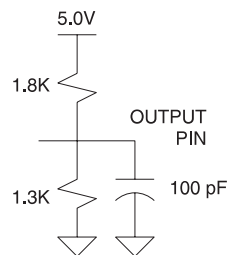
13. Pin Capacitance

f = 1 MHz, T = 25°C[1]

Symbol	Typ	Max	Units	Conditions
C_{IN}	4	10	pF	V_{IN} = 0V
C_{OUT}	8	12	pF	V_{OUT} = 0V

Note: 1.   This parameter is characterized and is not 100% tested.
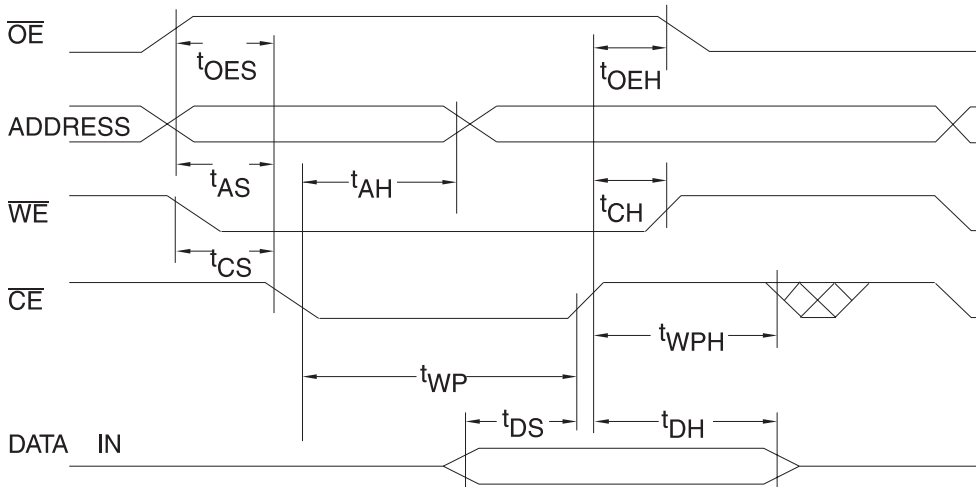
14. AC Write Characteristics

Symbol	Parameter	Min	Max	Units
t_{AS}, t_{OES}	Address, $\overline{OE}$ Set-up Time	0		ns
t_{AH}	Address Hold Time	50		ns
t_{CS}	Chip Select Set-up Time	0		ns
t_{CH}	Chip Select Hold Time	0		ns
t_{WP}	Write Pulse Width ($\overline{WE}$ or $\overline{CE}$)	100		ns
t_{DS}	Data Set-up Time	50		ns
t_{DH}, t_{OEH}	Data, $\overline{OE}$ Hold Time	0		ns

15. AC Write Waveforms

15.1 $\overline{WE}$ Controlled
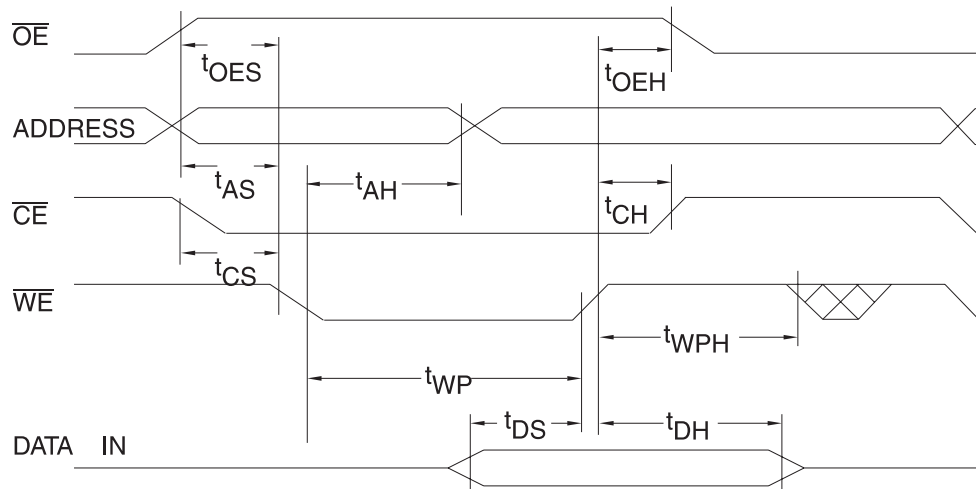
15.2 $\overline{CE}$ Controlled

16. Page Mode Characteristics

Symbol	Parameter	Min	Max	Units
t_{WC}	Write Cycle Time		10	ms
t_{AS}	Address Set-up Time	0		ns
t_{AH}	Address Hold Time	50		ns
t_{DS}	Data Set-up Time	50		ns
t_{DH}	Data Hold Time	0		ns
t_{WP}	Write Pulse Width	100		ns
t_{BLC}	Byte Load Cycle Time		150	µs
t_{WPH}	Write Pulse Width High	50		ns

17. Page Mode Write Waveforms[1][2]
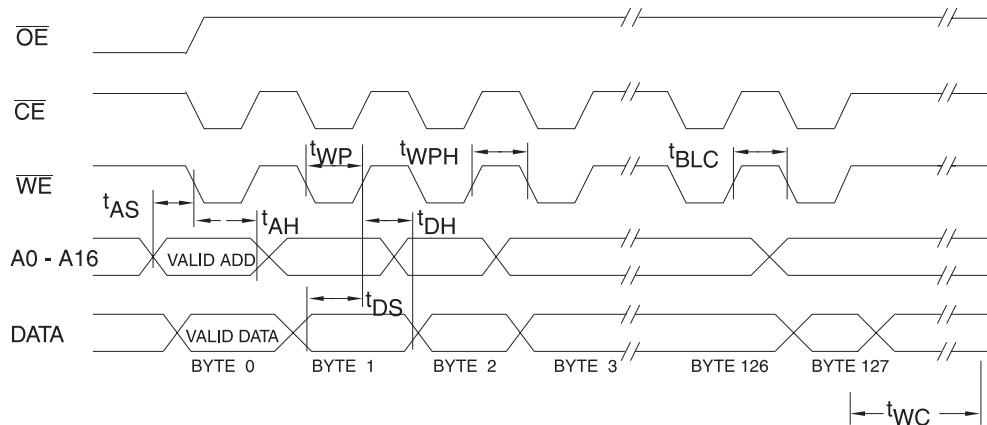
Notes: 1. A7 through A16 must specify the same page address during each high to low transition of $\overline{WE}$ (or $\overline{CE}$).

2. $\overline{OE}$ must be high only when $\overline{WE}$ and $\overline{CE}$ are both low.
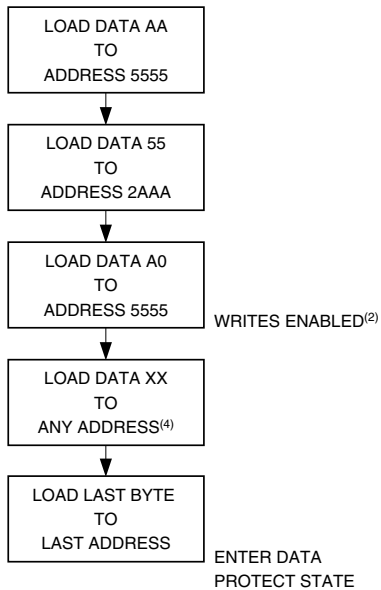
18. Chip Erase Waveforms
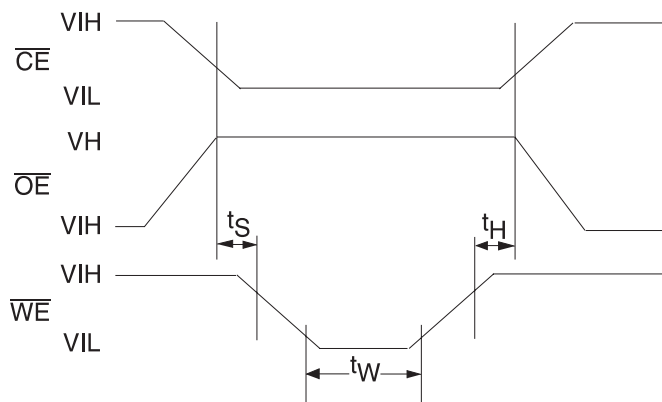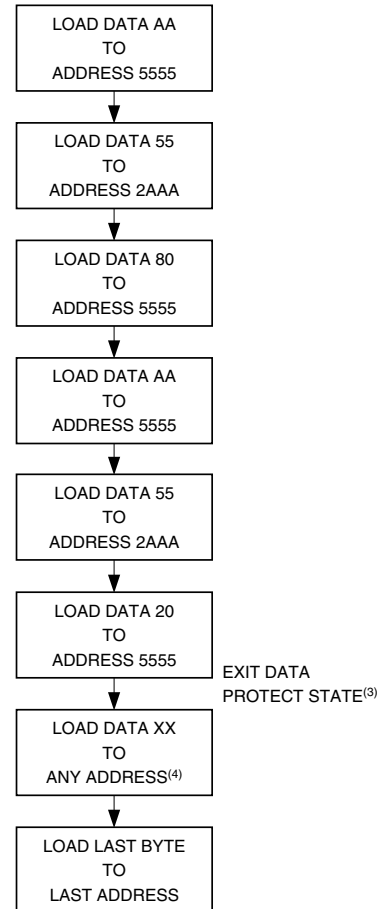

t_S = 5 µsec (min.)
t_W = t_H = 10 msec (min.)
V_H = 12.0V ±0.5V

19. Software Data Protection Enable Algorithm[1]

```
┌─────────────────┐
│  LOAD DATA AA   │
│      TO         │
│  ADDRESS 5555   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA 55   │
│      TO         │
│  ADDRESS 2AAA   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA A0   │
│      TO         │        WRITES ENABLED[2]
│  ADDRESS 5555   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA XX   │
│      TO         │
│ ANY ADDRESS[4]  │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│ LOAD LAST BYTE  │
│      TO         │
│  LAST ADDRESS   │        ENTER DATA
└─────────────────┘        PROTECT STATE
```

Notes: 1. Data Format: I/O7 - I/O0 (Hex);
Address Format: A14 - A0 (Hex).

2. Write Protect state will be activated at end of write even if no other data is loaded.

3. Write Protect state will be deactivated at end of write period even if no other data is loaded.

4. 1 to 128 bytes of data are loaded.

20. Software Data Protection Disable Algorithm[1]

```
┌─────────────────┐
│  LOAD DATA AA   │
│      TO         │
│  ADDRESS 5555   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA 55   │
│      TO         │
│  ADDRESS 2AAA   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA 80   │
│      TO         │
│  ADDRESS 5555   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA AA   │
│      TO         │
│  ADDRESS 5555   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA 55   │
│      TO         │
│  ADDRESS 2AAA   │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA 20   │
│      TO         │        EXIT DATA
│  ADDRESS 5555   │        PROTECT STATE[3]
└─────────────────┘
        │
        ▼
┌─────────────────┐
│  LOAD DATA XX   │
│      TO         │
│ ANY ADDRESS[4]  │
└─────────────────┘
        │
        ▼
┌─────────────────┐
│ LOAD LAST BYTE  │
│      TO         │
│  LAST ADDRESS   │
└─────────────────┘
```

21. Software Protected Write Cycle Waveforms[1][2][3]
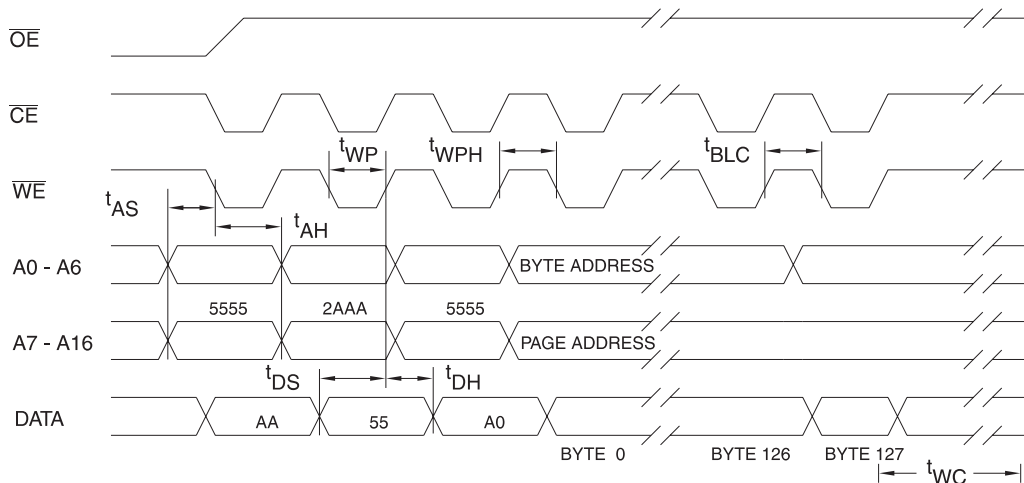
Notes: 1. A0 through A14 must conform to the addressing sequence for the first 3 bytes as shown above.

2. After the command sequence has been issued and a page write operation follows, the page address inputs (A7 - A16) must be the same for each high to low transition of $\overline{WE}$ (or $\overline{CE}$).

3. $\overline{OE}$ must be high only when $\overline{WE}$ and $\overline{CE}$ are both low.

22. $\overline{\text{Data}}$ Polling Characteristics[1]

Symbol	Parameter	Min	Typ	Max	Units
t_{DH}	Data Hold Time	10			ns
t_{OEH}	$\overline{\text{OE}}$ Hold Time	10			ns
t_{OE}	$\overline{\text{OE}}$ to Output Delay[2]				ns
t_{WR}	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See AC Read Characteristics.

23. $\overline{\text{Data}}$ Polling Waveforms
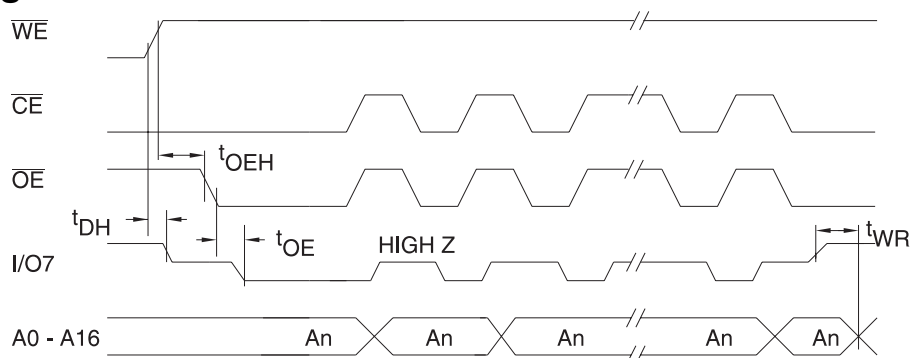
24. Toggle Bit Characteristics[1]

Symbol	Parameter	Min	Typ	Max	Units
t_{DH}	Data Hold Time	10			ns
t_{OEH}	$\overline{\text{OE}}$ Hold Time	10			ns
t_{OE}	$\overline{\text{OE}}$ to Output Delay[2]				ns
t_{OEHP}	$\overline{\text{OE}}$ High Pulse	150			ns
t_{WR}	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See AC Read Characteristics.

25. Toggle Bit Waveforms
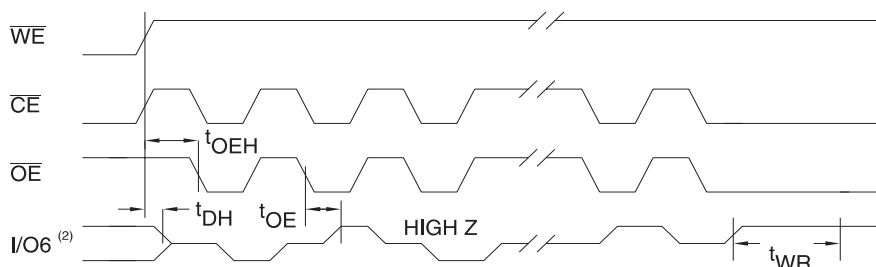
Notes: 1. Toggling either $\overline{\text{OE}}$ or $\overline{\text{CE}}$ or both $\overline{\text{OE}}$ and $\overline{\text{CE}}$ will operate toggle bit.

2. Beginning and ending state of I/O6 will vary.

3. Any address location may be used but the address should not vary.

26. Ordering Information[1]

26.1 Standard Package

| t_{ACC} (ns) | I_{CC} (mA) | | Ordering Code | Package | Operation Range |
	Active	Standby			
120	40	0.2	AT28C010(E)-12JI AT28C010(E)-12PI AT28C010(E)-12TI	32J 32P6 32T	Industrial (-40° to 85°C)
150	40	0.2	AT28C010(E)-15JI AT28C010(E)-15PI AT28C010(E)-15TI	32J 32P6 32T	

Note: 1.   See "Valid Part Numbers" on page 13.

26.2 Green Package Option (Pb/Halide-free)

| t_{ACC} (ns) | I_{CC} (mA) | | Ordering Code | Package | Operation Range |
	Active	Standby			
120	40	0.2	AT28C010-12JU AT28C010-12TU	32J 32T	Industrial (-40° to 85°C)
			AT28C010(E)-12JU AT28C010(E)-12PU AT28C010(E)-12TU	32J 32P6 32T	
150	40	0.2	AT28C010-15JU AT28C010-15TU	32J 32T	
			AT28C010(E)-15JU AT28C010(E)-15PU AT28C010(E)-15TU	32J 32P6 32T	

Package Type	
32J	32-lead, Plastic J-leaded Chip Carrier (PLCC)
32P6	32-lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)
32T	32-lead, Plastic Thin Small Outline Package (TSOP)
W	Die
Options	
Blank	Standard Device: Endurance = 10K Write Cycles; Write Time = 10 ms
E	High-endurance Option: Endurance = 100K Write Cycles

27. Valid Part Numbers

The following table lists standard Atmel products that can be ordered.

Device Numbers	Speed	Package and Temperature Combinations
AT28C010	12	JI, JU, PI, TI, TU, PU
AT28C010E	12	JI, PI, TI, JU, PU, TU
AT28C010	15	JI, JU, PI, TI, TU, PU
AT28C010E	15	JI, PI, TI, JU, PU, TU

28. Die Products

Reference Section: Parallel EEPROM Die Products

29. Packaging Information

29.1 32J – PLCC

1.14(0.045) X 45˚

PIN NO. 1
IDENTIFIER

1.14(0.045) X 45˚

0.318(0.0125)
0.191(0.0075)

B1 E2

E1 E

B

e

A2

A1

D1

A

D

0.51(0.020)MAX
45˚ MAX (3X)

D2
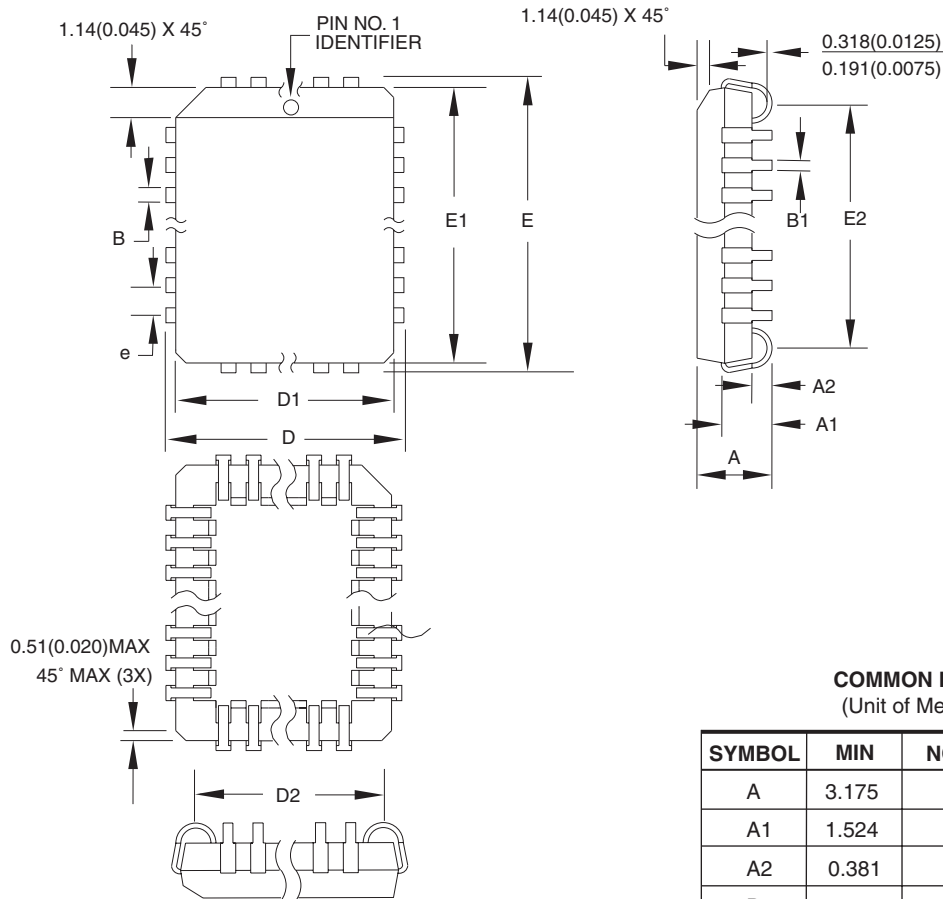
COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	3.175	–	3.556	
A1	1.524	–	2.413	
A2	0.381	–	–	
D	12.319	–	12.573	
D1	11.354	–	11.506	Note 2
D2	9.906	–	10.922	
E	14.859	–	15.113	
E1	13.894	–	14.046	Note 2
E2	12.471	–	13.487	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes: 1. This package conforms to JEDEC reference MS-016, Variation AE.
2. Dimensions D1 and E1 do not include mold protrusion.
Allowable protrusion is .010"(0.254 mm) per side. Dimension D1
and E1 include mold mismatch and are measured at the extreme
material condition at the upper or lower parting line.
3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**32J**, 32-lead, Plastic J-leaded Chip Carrier (PLCC)	32J	B

AT28C010

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29.2   32P6 – PDIP
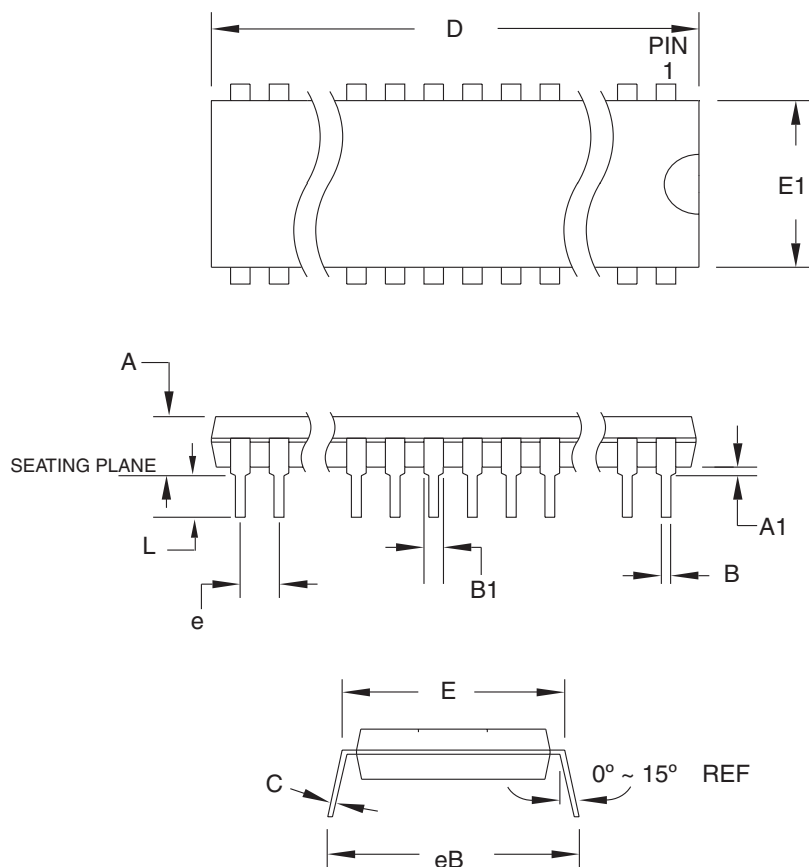
COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	4.826	
A1	0.381	–	–	
D	41.783	–	42.291	Note 1
E	15.240	–	15.875	
E1	13.462	–	13.970	Note 1
B	0.356	–	0.559	
B1	1.041	–	1.651	
L	3.048	–	3.556	
C	0.203	–	0.381	
eB	15.494	–	17.526	
e	2.540 TYP			

Note: 1. Dimensions D and E1 do not include mold Flash or Protrusion.
Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

09/28/01

	TITLE	DRAWING NO.	REV.
AIMEL 2325 Orchard Parkway San Jose, CA 95131	**32P6**, 32-lead (0.600"/15.24 mm Wide) Plastic Dual Inline Package (PDIP)	32P6	B

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29.3 32T – TSOP

Notes: 1. This package conforms to JEDEC reference MO-142, Variation BD.
2. Dimensions D1 and E do not include mold protrusion. Allowable protrusion on E is 0.15 mm per side and on D1 is 0.25 mm per side.
3. Lead coplanarity is 0.10 mm maximum.
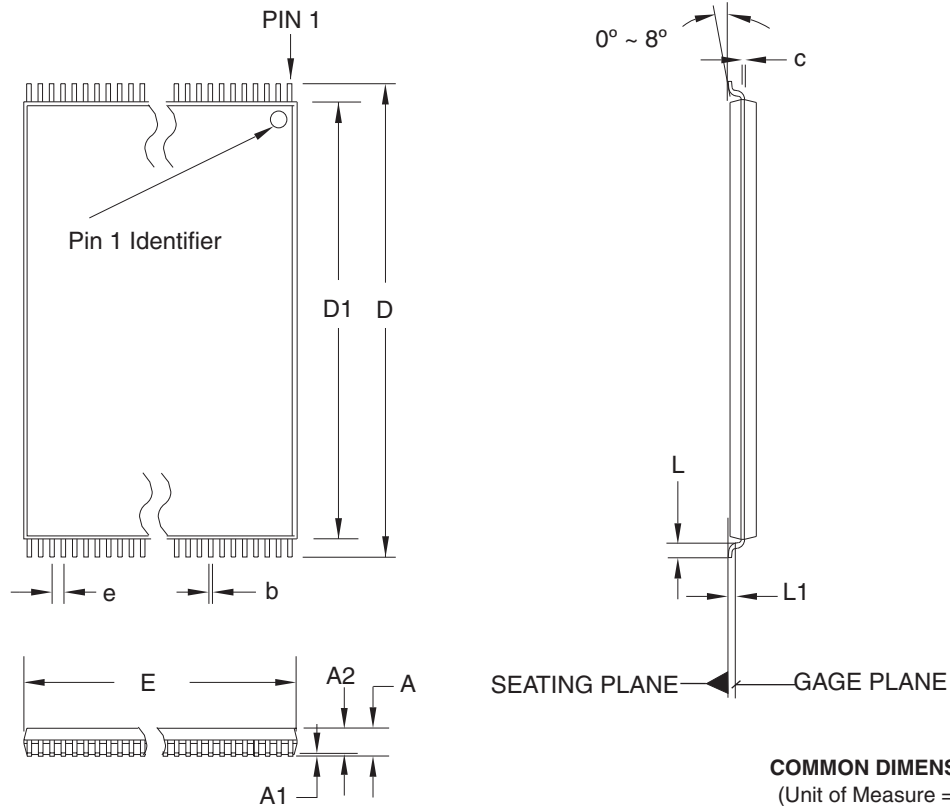
COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	19.80	20.00	20.20	
D1	18.30	18.40	18.50	Note 2
E	7.90	8.00	8.10	Note 2
L	0.50	0.60	0.70	
L1	0.25 BASIC			
b	0.17	0.22	0.27	
c	0.10	–	0.21	
e	0.50 BASIC			

10/18/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**32T**, 32-lead (8 x 20 mm Package) Plastic Thin Small Outline Package, Type I (TSOP)	32T	B

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